Tyrone Camarero Specifications

Camarero: RDI300A2G-424

Kev Feature

- Dual Intel® Xeon® 6700P, 6500P and 6700E-series processors Upto 350W TDP
- 8 x NVIDIA H200 NVL or RTX PRO 6000 Blackwell Server Edition PCIe GPU cards
- Supports 16+16 DDR5 RDIMM Expandable Memory
- 10 x PCle 5.0 Expansion Slots
- Latest Aspeed AST2600 BMC Controller
- Support 4 x 2.5" NVMe + 20 x 2.5" SATA/SAS Hot Swappable Drives
- 80+ Titanium CRPS Power Supply
- Enhanced Security with TPM 2.0





Processor/Cache

Supports Dual Intel® Xeon® 6700P, 6500P and **Processor**

6700E-series processors Upto 350W TDP

(LGA 4710)

System Memory

Memory Capacity Supports 16+16 DDR5 Expandable Memory,

Max Frequency: RDIMM

6400MHz(1DPC), 5200MHz(2DPC), MRDIMM: 8000MT/s (1DPC only)

Max. Capacity per DIMM: 128GB(RDIMM),

Upto 4TB System Memory,

MRDIMM: 64GB

Expansion Slot

8 x16 PCle5.0 FHFL (Double Width) **PCI-Express**

1 x16 PCle5.0 FHHL (Single Width) 1x8 PCle5.0 FHHL (Single Width)

Indicators

Indicators 1x Power LED Button (Front)

1 x UID LED Button (Front)

1 x System Fault LED (Front) 24 x HDD LED (Front)

Environment

Environment System Operating Temperature: 0°C ~ 35°C

Non-operating Temperature: -20°C ~ 70°C'

Non-operating Relative Humidity: 5% to

85% (non-condensing)

Front Panel

1 x 1000Base-T Dedicated Server Ports

Management Port (Rear)

2 x 1GBase-T Ethernet ports with Intel® i350

(Rear)

2 x USB 3.2 Gen1 Type-A Port (Rear) 4 x USB 3.2 Gen1 Type-A Port (Front) 1 x Display port DB15 (Rear)

Drive bays

Support 4 x 2.5" NVMe + 20 x 2.5" **HDD Bays**

SATA/SAS* Hot Swappable Drives (*RAID/HBA Card Required for SAS/SATA

Support)

Backplane: 24 x SAS/SATA/NVMe

Passive(Configurable)

1 x M.2 PCle5.0 x4 of form factor 22110/2280

Security

TPM 2.0 Security

Power Supply

Power Supply 2700W (3+1) 80+ CRPS Titanium Certified

Form Factor

4U Rackmount Form Factor

Dimensions

Dimensions 438mm(W) x 176mm(H) x 786mm(D)

Email: Info@tyronesystems.com For more/current product information, Visit www.tyronesystems.com

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